Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

⚠ REMINDERS

- Product information in this catalog is as of October 2015. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

  Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.

- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.

- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.
  Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

  In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").
  It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.

- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.

- Caution for export
  Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

MULTILAYER CHIP BEAD INDUCTORS(BK SERIES)

WAVE* REFLOW

*Except for BK0402, BK0603, BK1005

■PARTS NUMBER

* Operating Temp.: −55～+125℃

B K △	1 6 0 8	H S	1 2 1	—	T	△
①	②	③	④	⑤	⑥	⑦

△=Blank space

①Series name

Code	Series name
BK△	Multilayer chip bead inductor

②Dimensions (L×W)

Code	Type (inch)	Dimensions (L×W) [mm]
0402	0402 (01005)	0.4×0.2
0603	0603 (0201)	0.6×0.3
1005	1005 (0402)	1.0×0.5
1608	1608 (0603)	1.6×0.8
2125	2125 (0805)	2.0×1.25

③Material

Code	Material
HW	Refer to impedance curves for material differences
HS	
HR	
HM	
LM	
LL	
TS	
TM	

④Nominal impedance

Code (example)	Nominal impedance [Ω]
150	15
101	100
102	1000

⑤Characteristics

Code	Characteristics
—	Standard

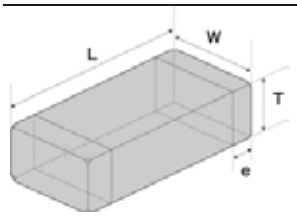
⑥Packaging

Code	Packaging
T	Taping

⑦Internal code

Code	Internal code
△	Standard

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Type	L	W	T	e	Standard quantity [pcs]	
					Paper tape	Embossed tape
BK 0402 (01005)	0.40±0.02 (0.016±0.001)	0.20±0.02 (0.008±0.001)	0.20±0.02 (0.008±0.001)	0.10+0.04/−0.03 (0.004+0.002/−0.001)	20000	—
BK 0603 (0201)	0.60±0.03 (0.024±0.001)	0.30±0.03 (0.012±0.001)	0.30±0.03 (0.012±0.001)	0.15±0.05 (0.006±0.002)	15000	—
BK 1005 (0402)	1.00±0.05 (0.039±0.002)	0.50±0.05 (0.020±0.002)	0.50±0.05 (0.020±0.002)	0.25±0.10 (0.010±0.004)	10000	—
BK 1608 (0603)	1.6±0.15 (0.063±0.006)	0.8±0.15 (0.031±0.006)	0.8±0.15 (0.031±0.006)	0.3±0.2 (0.012±0.008)	4000	—
BK 2125 (0805)	2.0+0.3/−0.1 (0.079+0.012/−0.004)	1.25±0.2 (0.049±0.008)	0.85±0.2 (0.033±0.008)	0.5±0.3 (0.020±0.012)	4000	—
	2.0+0.3/−0.1 (0.079+0.012/−0.004)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.3 (0.020±0.012)	—	2000

Unit: mm (inch)

●BK 0402

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 0402HS100-T	RoHS	10	±5Ω	100	0.10	540	0.20 ±0.02
BK 0402HS700-T	RoHS	70	±25%	100	0.37	280	0.20 ±0.02
BK 0402HS121-T	RoHS	120	±25%	100	0.53	240	0.20 ±0.02
BK 0402HM100-T	RoHS	10	±5Ω	100	0.07	750	0.20 ±0.02
BK 0402HM750-T	RoHS	75	±25%	100	0.45	260	0.20 ±0.02
BK 0402HM121-T	RoHS	120	±25%	100	0.60	220	0.20 ±0.02
BK 0402HM151-T	RoHS	150	±25%	100	0.65	200	0.20 ±0.02
BK 0402HM181-T	RoHS	180	±25%	100	0.75	200	0.20 ±0.02
BK 0402HM241-T	RoHS	240	±25%	100	0.90	200	0.20 ±0.02
BK 0402HM331-T	RoHS	330	±25%	100	1.20	150	0.20 ±0.02
BK 0402LL220-T	RoHS	22	±25%	100	0.70	150	0.20 ±0.02

●BK 0603

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 0603HS220-T	RoHS	22	±25%	100	0.065	500	0.30 ±0.03
BK 0603HS330-T	RoHS	33	±25%	100	0.070	500	0.30 ±0.03
BK 0603HS800-T	RoHS	80	±25%	100	0.40	200	0.30 ±0.03
BK 0603HS121-T	RoHS	120	±25%	100	0.45	200	0.30 ±0.03
BK 0603HS241-T	RoHS	240	±25%	100	0.65	200	0.30 ±0.03
BK 0603HS601-T	RoHS	600	±25%	100	1.20	150	0.30 ±0.03
BK 0603HM600-T	RoHS	60	±25%	100	0.25	200	0.30 ±0.03
BK 0603HM121-T	RoHS	120	±25%	100	0.40	200	0.30 ±0.03
BK 0603HM241-T	RoHS	240	±25%	100	0.80	200	0.30 ±0.03
BK 0603HM471-T	RoHS	470	±25%	100	1.05	100	0.30 ±0.03
BK 0603HM601-T	RoHS	600	±25%	100	1.20	100	0.30 ±0.03
BK 0603HR121-T	RoHS	120	±25%	100	0.23	450	0.30 ±0.03
BK 0603HR241-T	RoHS	240	±25%	100	0.38	350	0.30 ±0.03
BK 0603HR601-T	RoHS	600	±25%	100	0.80	250	0.30 ±0.03
BK 0603HR102-T	RoHS	1000	±25%	100	1.15	220	0.30 ±0.03
BK 0603HR122-T	RoHS	1200	±25%	100	1.30	200	0.30 ±0.03
BK 0603LL100-T	RoHS	10	±25%	100	0.25	200	0.30 ±0.03
BK 0603LL220-T	RoHS	22	±25%	100	0.45	200	0.30 ±0.03
BK 0603LL330-T	RoHS	33	±25%	100	0.55	150	0.30 ±0.03
BK 0603LL470-T	RoHS	47	±25%	100	0.70	150	0.30 ±0.03
BK 0603LL560-T	RoHS	56	±25%	100	1.00	100	0.30 ±0.03
BK 0603LL800-T	RoHS	80	±25%	100	1.30	100	0.30 ±0.03
BK 0603LL121-T	RoHS	120	±25%	100	1.50	100	0.30 ±0.03
BK 0603TS800-T	RoHS	80	±25%	100	0.18	500	0.30 ±0.03
BK 0603TS121-T	RoHS	120	±25%	100	0.23	450	0.30 ±0.03
BK 0603TS241-T	RoHS	240	±25%	100	0.32	400	0.30 ±0.03
BK 0603TS601-T	RoHS	600	±25%	100	0.75	270	0.30 ±0.03
BK 0603TM800-T	RoHS	80	±25%	100	0.18	450	0.30 ±0.03
BK 0603TM121-T	RoHS	120	±25%	100	0.23	400	0.30 ±0.03
BK 0603TM241-T	RoHS	240	±25%	100	0.38	300	0.30 ±0.03
BK 0603TM601-T	RoHS	600	±25%	100	0.85	250	0.30 ±0.03

●BK 1005

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 1005HW680-T	RoHS	68	±25%	100	0.17	500	0.50 ±0.05
BK 1005HW121-T	RoHS	120	±25%	100	0.24	450	0.50 ±0.05
BK 1005HW241-T	RoHS	240	±25%	100	0.31	400	0.50 ±0.05
BK 1005HW431-T	RoHS	430	±25%	100	0.50	350	0.50 ±0.05
BK 1005HW601-T	RoHS	600	±25%	100	0.60	300	0.50 ±0.05
BK 1005HS100-T	RoHS	10	±25%	100	0.03	1,000	0.50 ±0.05
BK 1005HS330-T	RoHS	33	±25%	100	0.06	700	0.50 ±0.05
BK 1005HS680-T	RoHS	68	±25%	100	0.10	700	0.50 ±0.05
BK 1005HS800-T	RoHS	80	±25%	100	0.10	700	0.50 ±0.05
BK 1005HS121-T	RoHS	120	±25%	100	0.20	500	0.50 ±0.05
BK 1005HS241-T	RoHS	240	±25%	100	0.30	400	0.50 ±0.05
BK 1005HS431-T	RoHS	430	±25%	100	0.45	350	0.50 ±0.05
BK 1005HS601-T	RoHS	600	±25%	100	0.55	300	0.50 ±0.05
BK 1005HS102-T	RoHS	1000	±25%	100	0.58	300	0.50 ±0.05
BK 1005HR601-T	RoHS	600	±25%	100	0.60	300	0.50 ±0.05
BK 1005HM750-T	RoHS	75	±25%	100	0.18	350	0.50 ±0.05
BK 1005HM121-T	RoHS	120	±25%	100	0.18	300	0.50 ±0.05
BK 1005HM241-T	RoHS	240	±25%	100	0.30	300	0.50 ±0.05
BK 1005HM471-T	RoHS	470	±25%	100	0.45	250	0.50 ±0.05
BK 1005HM601-T	RoHS	600	±25%	100	0.50	250	0.50 ±0.05
BK 1005HM102-T	RoHS	1000	±25%	100	0.70	150	0.50 ±0.05
BK 1005LL100-T	RoHS	10	±25%	100	0.11	500	0.50 ±0.05
BK 1005LL220-T	RoHS	22	±25%	100	0.18	400	0.50 ±0.05
BK 1005LL330-T	RoHS	33	±25%	100	0.25	400	0.50 ±0.05
BK 1005LL470-T	RoHS	47	±25%	100	0.33	350	0.50 ±0.05
BK 1005LL680-T	RoHS	68	±25%	100	0.31	400	0.50 ±0.05
BK 1005LL121-T	RoHS	120	±25%	100	0.45	350	0.50 ±0.05
BK 1005LL181-T	RoHS	180	±25%	100	0.50	300	0.50 ±0.05
BK 1005LL241-T	RoHS	240	±25%	100	0.70	250	0.50 ±0.05
BK 1005LM182-T	RoHS	1800	±25%	100	0.90	120	0.50 ±0.05

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●BK 1608

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 1608HW121-T	RoHS	120	±25%	100	0.15	600	0.80 ±0.15
BK 1608HW241-T	RoHS	240	±25%	100	0.25	450	0.80 ±0.15
BK 1608HW431-T	RoHS	430	±25%	100	0.30	400	0.80 ±0.15
BK 1608HW601-T	RoHS	600	±25%	100	0.40	300	0.80 ±0.15
BK 1608HS220-T	RoHS	22	±25%	100	0.05	1,500	0.80 ±0.15
BK 1608HS330-T	RoHS	33	±25%	100	0.08	1,200	0.80 ±0.15
BK 1608HS470-T	RoHS	47	±25%	100	0.10	900	0.80 ±0.15
BK 1608HS600-T	RoHS	60	±25%	100	0.10	800	0.80 ±0.15
BK 1608HS800-T	RoHS	80	±25%	100	0.10	600	0.80 ±0.15
BK 1608HS121-T	RoHS	120	±25%	100	0.18	500	0.80 ±0.15
BK 1608HS241-T	RoHS	240	±25%	100	0.25	400	0.80 ±0.15
BK 1608HS601-T	RoHS	600	±25%	100	0.45	350	0.80 ±0.15
BK 1608HS102-T	RoHS	1000	±25%	100	0.60	300	0.80 ±0.15
BK 1608HM121-T	RoHS	120	±25%	100	0.20	350	0.80 ±0.15
BK 1608HM241-T	RoHS	240	±25%	100	0.35	300	0.80 ±0.15
BK 1608HM471-T	RoHS	470	±25%	100	0.45	250	0.80 ±0.15
BK 1608HM601-T	RoHS	600	±25%	100	0.60	250	0.80 ±0.15
BK 1608HM102-T	RoHS	1000	±25%	100	0.70	200	0.80 ±0.15
BK 1608LL300-T	RoHS	30	±25%	100	0.20	500	0.80 ±0.15
BK 1608LL470-T	RoHS	47	±25%	100	0.30	400	0.80 ±0.15
BK 1608LL560-T	RoHS	56	±25%	100	0.30	400	0.80 ±0.15
BK 1608LL680-T	RoHS	68	±25%	100	0.35	300	0.80 ±0.15
BK 1608LL121-T	RoHS	120	±25%	100	0.50	300	0.80 ±0.15
BK 1608LL181-T	RoHS	180	±25%	100	0.65	250	0.80 ±0.15
BK 1608LL241-T	RoHS	240	±25%	100	0.80	250	0.80 ±0.15
BK 1608LL331-T	RoHS	330	±25%	100	0.85	200	0.80 ±0.15
BK 1608LL431-T	RoHS	430	±25%	100	0.85	200	0.80 ±0.15
BK 1608LL511-T	RoHS	510	±25%	100	0.90	200	0.80 ±0.15
BK 1608LL681-T	RoHS	680	±25%	100	1.00	150	0.80 ±0.15
BK 1608LM751-T	RoHS	750	±25%	100	0.60	300	0.80 ±0.15
BK 1608LM152-T	RoHS	1500	±25%	100	0.75	250	0.80 ±0.15
BK 1608LM182-T	RoHS	1800	±25%	100	0.85	200	0.80 ±0.15
BK 1608LM252-T	RoHS	2500	±25%	100	1.10	200	0.80 ±0.15
BK 1608TS431-T	RoHS	430	±25%	100	0.21±30%	400	0.80 ±0.15
BK 1608TS601-T	RoHS	600	±25%	100	0.27±30%	350	0.80 ±0.15
BK 1608TS102-T	RoHS	1000	±25%	100	0.30±30%	300	0.80 ±0.15

●BK 2125

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 2125HS150-T	RoHS	15	±25%	100	0.05	1,200	0.85 ±0.2
BK 2125HS220-T	RoHS	22	±25%	100	0.05	1,200	0.85 ±0.2
BK 2125HS330-T	RoHS	33	±25%	100	0.05	1,200	0.85 ±0.2
BK 2125HS470-T	RoHS	47	±25%	100	0.05	1,000	0.85 ±0.2
BK 2125HS750-T	RoHS	75	±25%	100	0.10	1,000	0.85 ±0.2
BK 2125HS101-T	RoHS	100	±25%	100	0.10	900	0.85 ±0.2
BK 2125HS121-T	RoHS	120	±25%	100	0.15	800	0.85 ±0.2
BK 2125HS241-T	RoHS	240	±25%	100	0.20	600	0.85 ±0.2
BK 2125HS431-T	RoHS	430	±25%	100	0.25	500	0.85 ±0.2
BK 2125HS601-T	RoHS	600	±25%	100	0.30	500	0.85 ±0.2
BK 2125HS102-T	RoHS	1000	±25%	100	0.40	300	0.85 ±0.2
BK 2125HM121-T	RoHS	120	±25%	100	0.15	800	0.85 ±0.2
BK 2125HM241-T	RoHS	240	±25%	100	0.20	600	0.85 ±0.2
BK 2125HM471-T	RoHS	470	±25%	100	0.25	500	0.85 ±0.2
BK 2125HM601-T	RoHS	600	±25%	100	0.25	500	0.85 ±0.2
BK 2125HM102-T	RoHS	1000	±25%	100	0.35	400	0.85 ±0.2
BK 2125LL560-T	RoHS	56	±25%	100	0.20	600	0.85 ±0.2
BK 2125LL121-T	RoHS	120	±25%	100	0.30	400	0.85 ±0.2
BK 2125LL241-T	RoHS	240	±25%	100	0.35	300	0.85 ±0.2
BK 2125LM751-T	RoHS	750	±25%	100	0.30	400	0.85 ±0.2
BK 2125LM152-T	RoHS	1500	±25%	100	0.35	400	0.85 ±0.2
BK 2125LM182-T	RoHS	1800	±25%	100	0.45	300	1.25 ±0.2
BK 2125LM252-T	RoHS	2500	±25%	100	0.75	200	1.25 ±0.2

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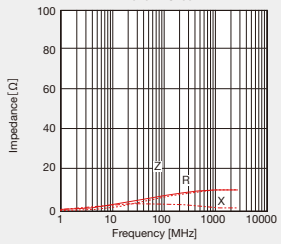
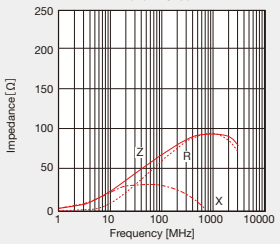
ELECTRICAL CHARACTERISTICS

BK0402

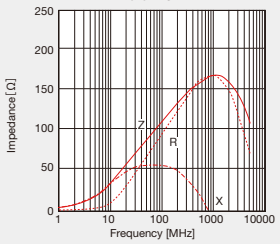
BK0402 HS100



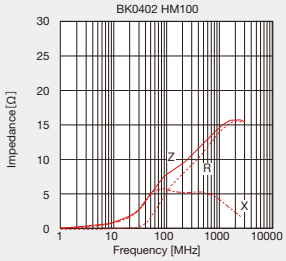
BK0402 HS700



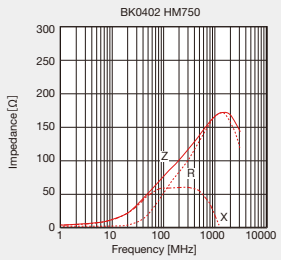
BK0402 HS121



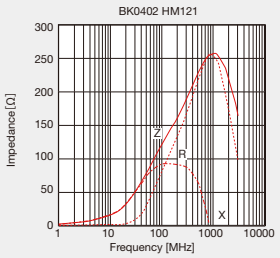
BK0402 HM100



BK0402 HM750



BK0402 HM121



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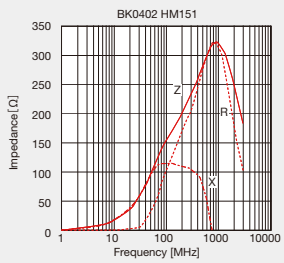

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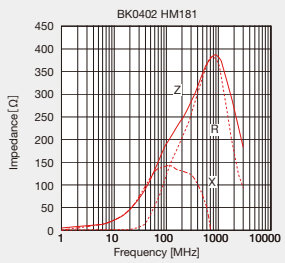

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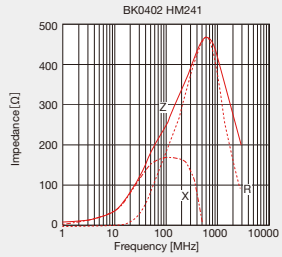
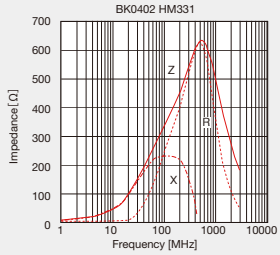
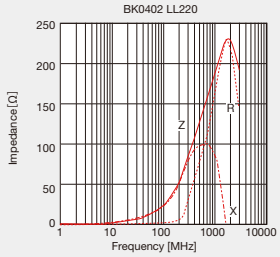


BK0402 HM331



BK0402 LL220



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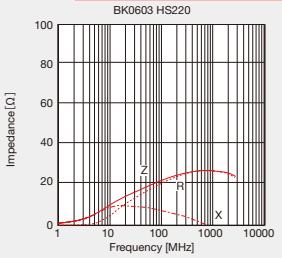

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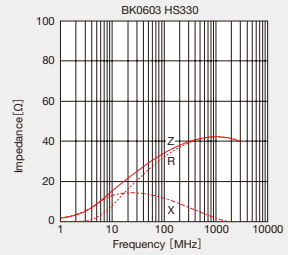

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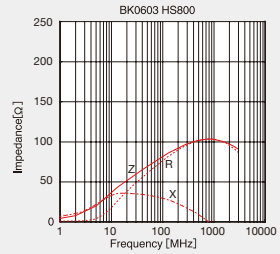

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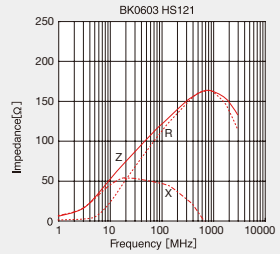

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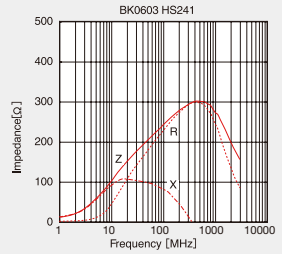

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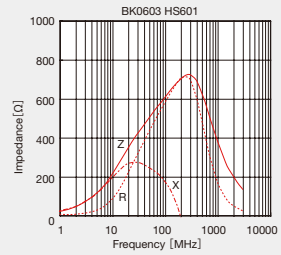

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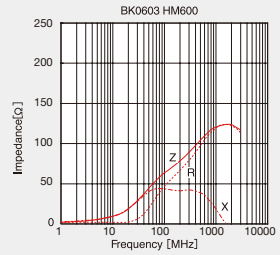

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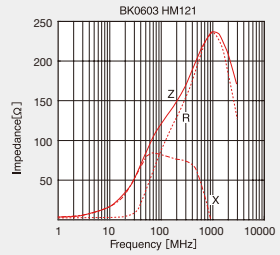

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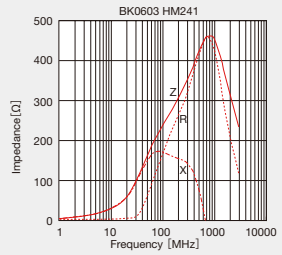

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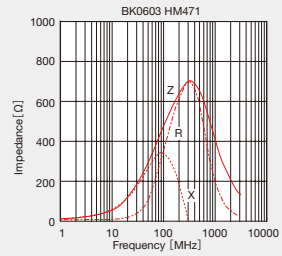

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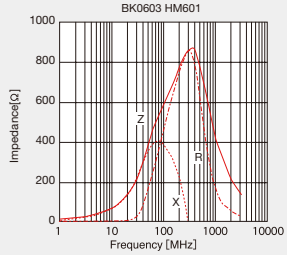

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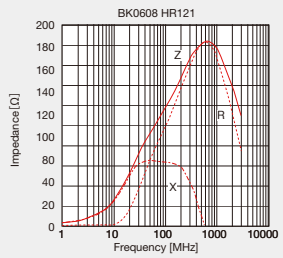

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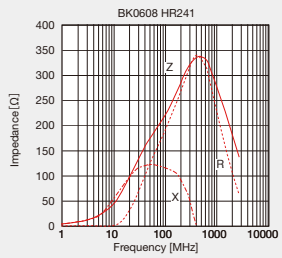

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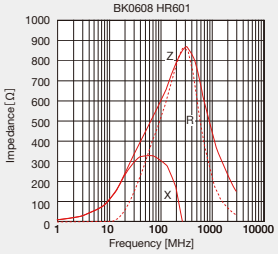
BK0608 HR601



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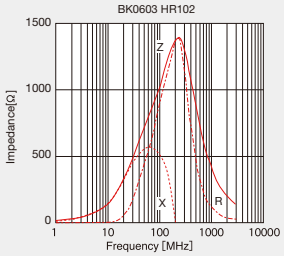

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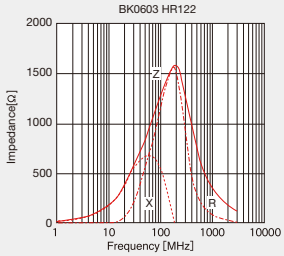

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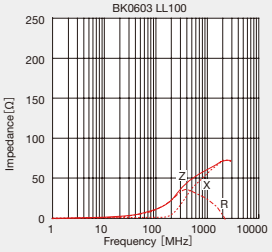

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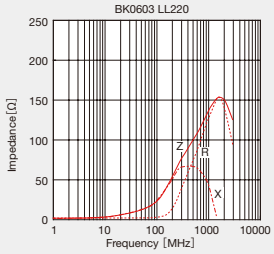

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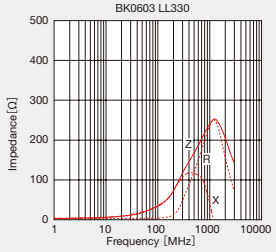

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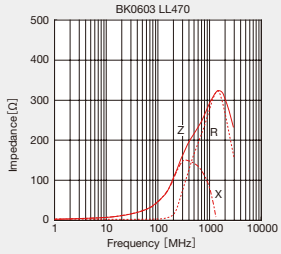

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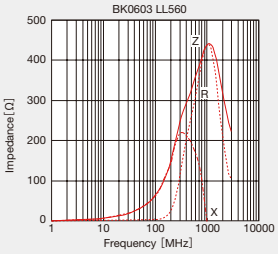

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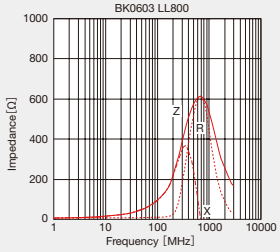

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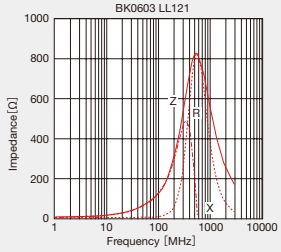

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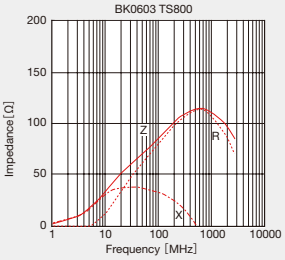

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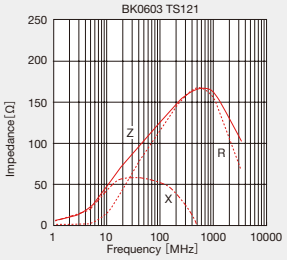

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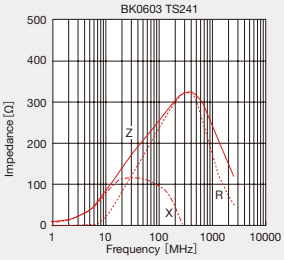

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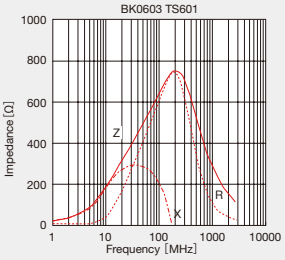

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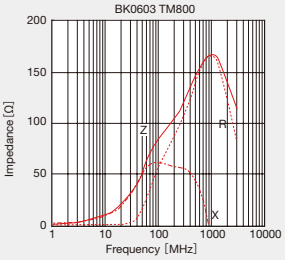

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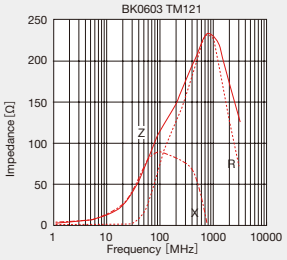

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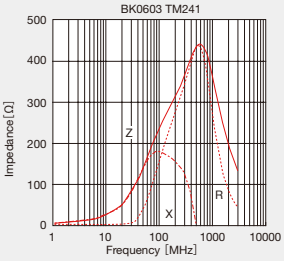

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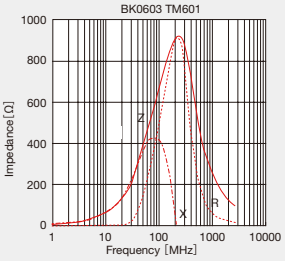

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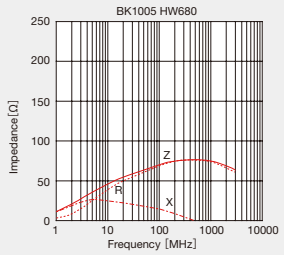

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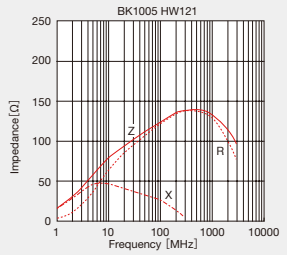

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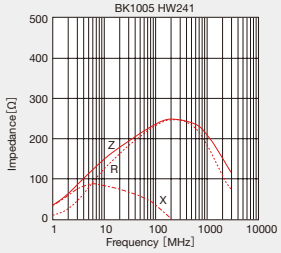

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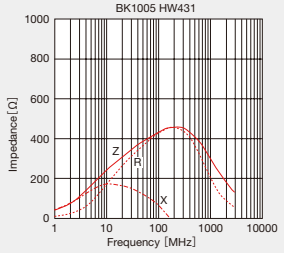

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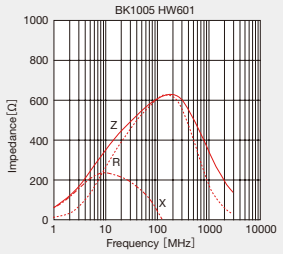

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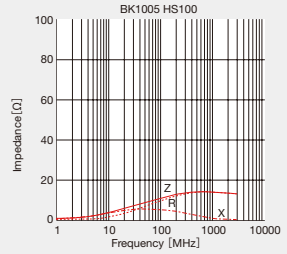

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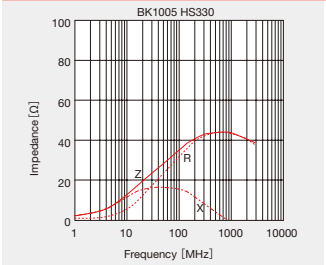

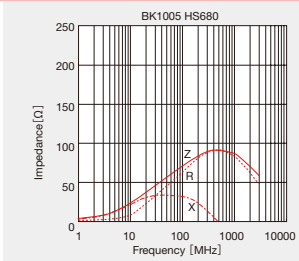

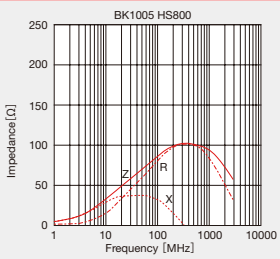

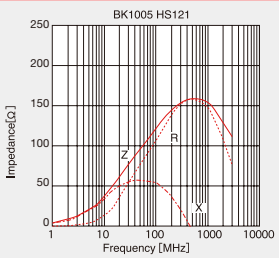

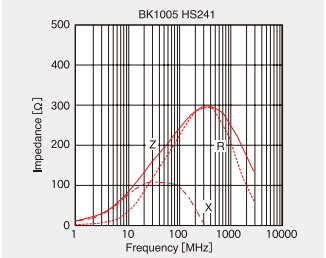

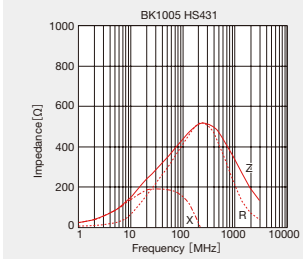

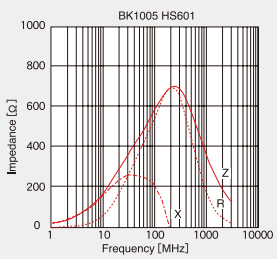

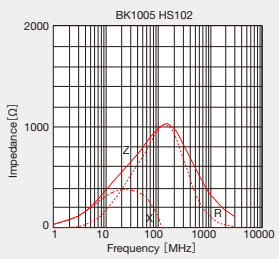

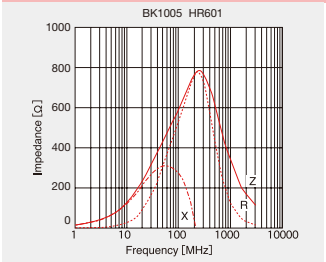

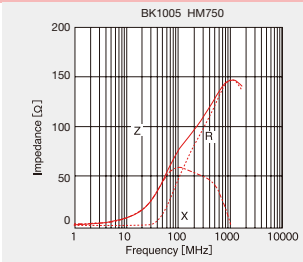

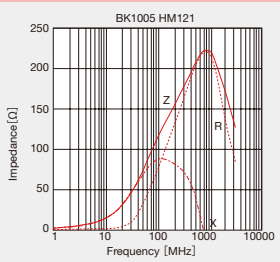

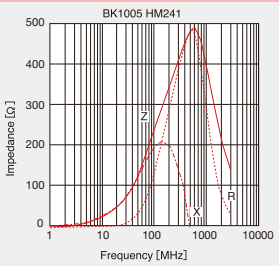

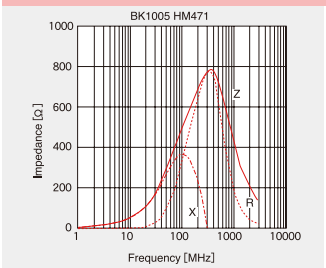

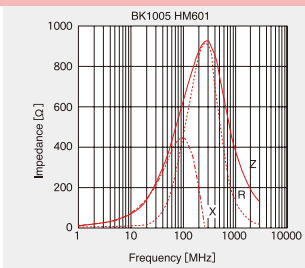

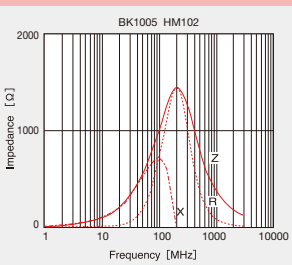

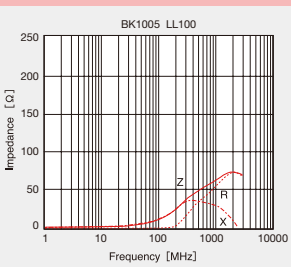

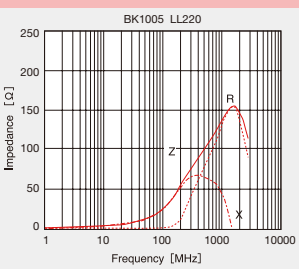

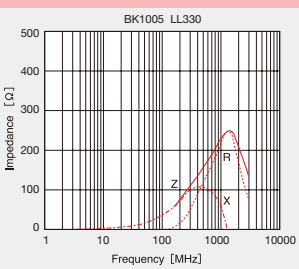

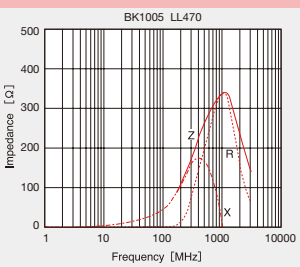

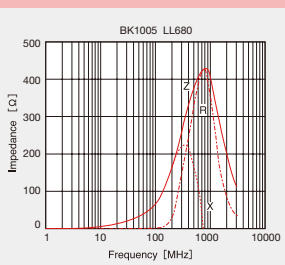

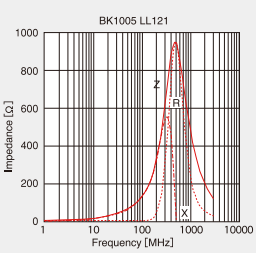

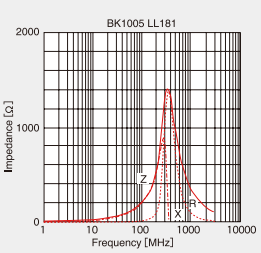

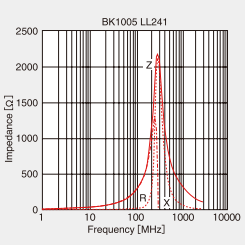

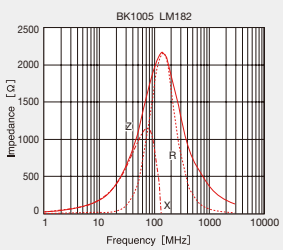

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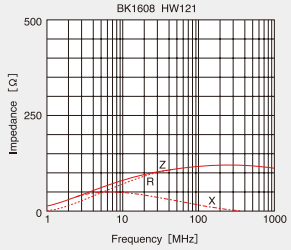
BK1608

BK1608 HW121



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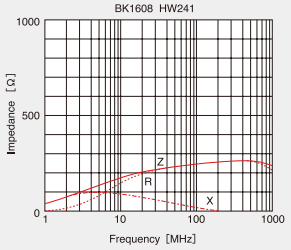

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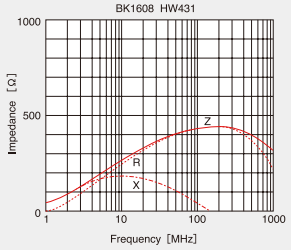

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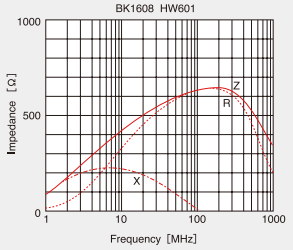

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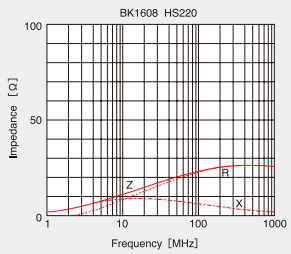

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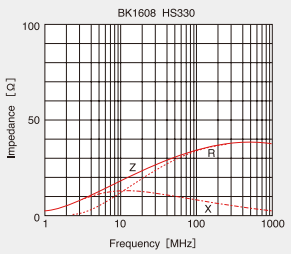

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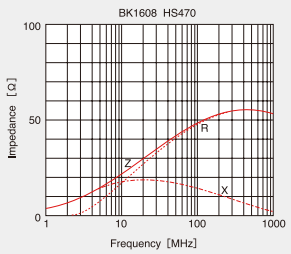

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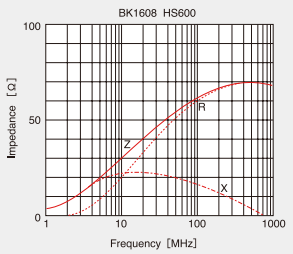

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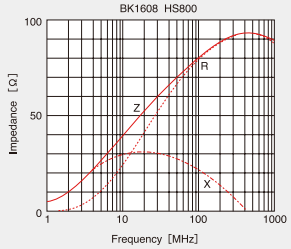

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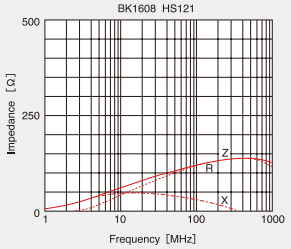

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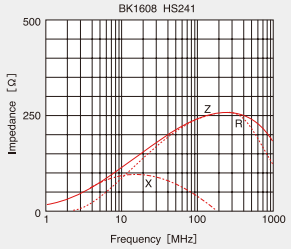

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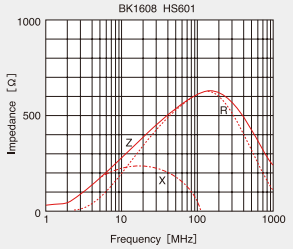

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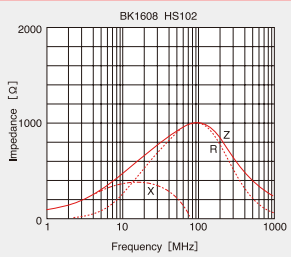

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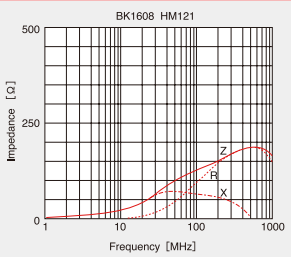

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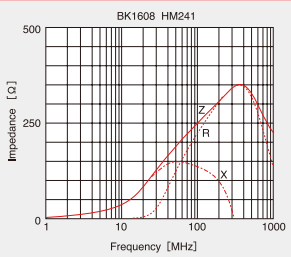

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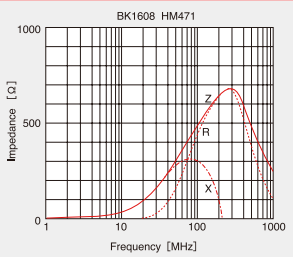

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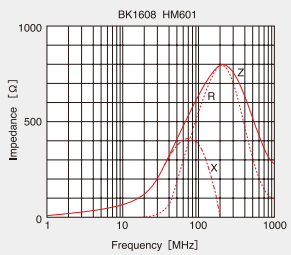

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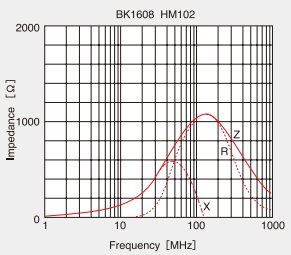

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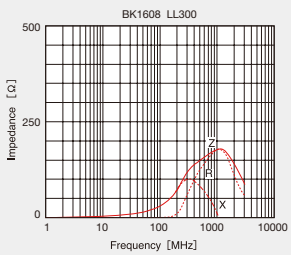

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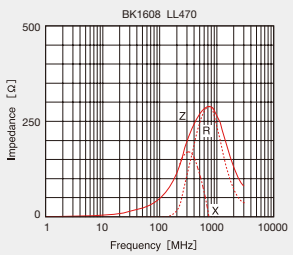

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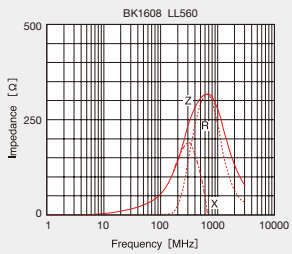

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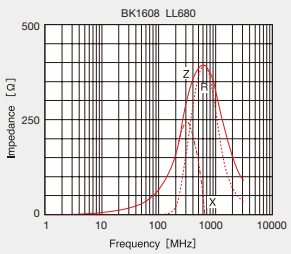

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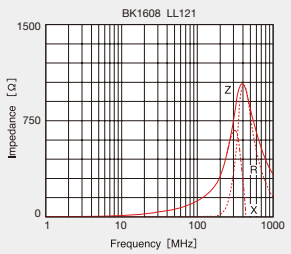

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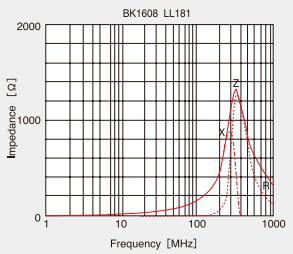

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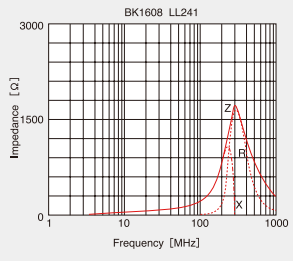
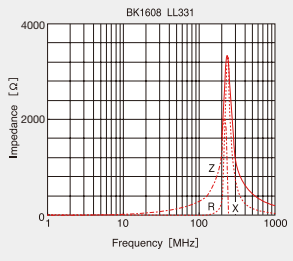
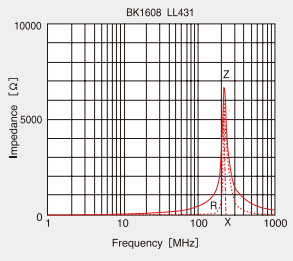
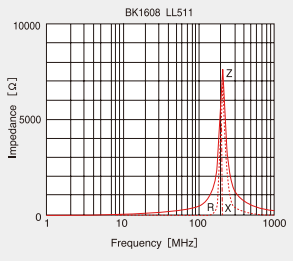
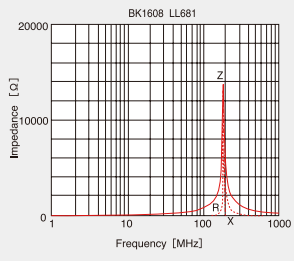
ELECTRICAL CHARACTERISTICS

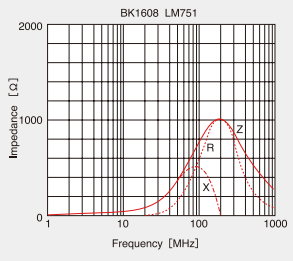


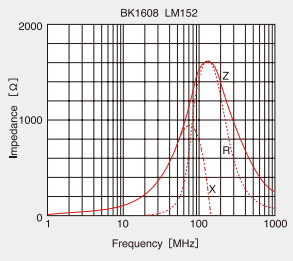


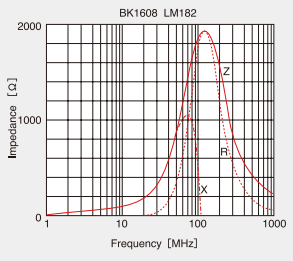


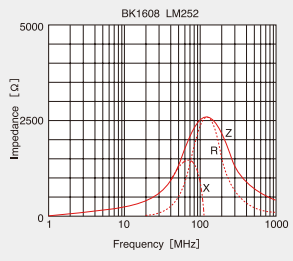


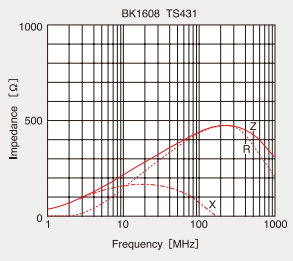


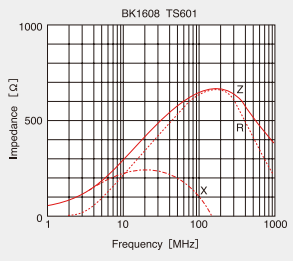


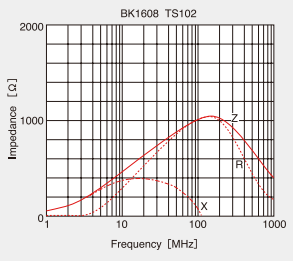












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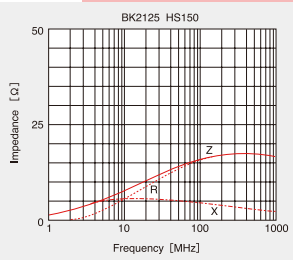

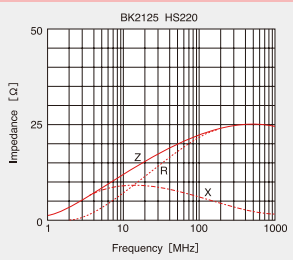

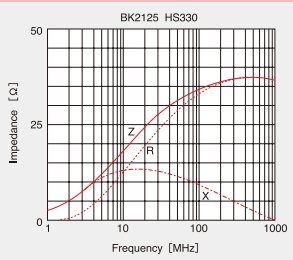

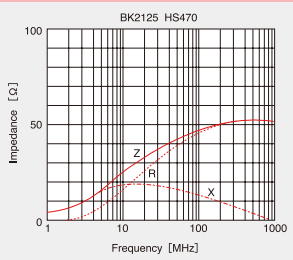

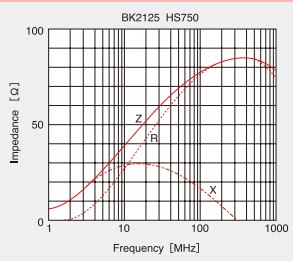

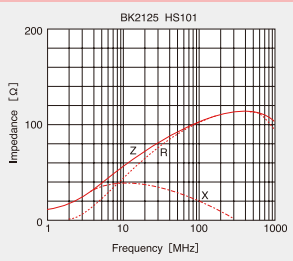

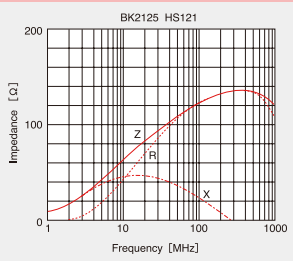

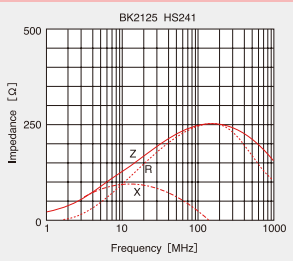

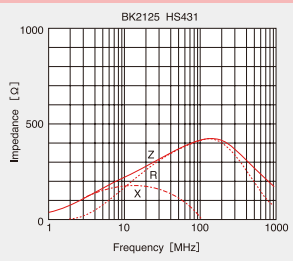

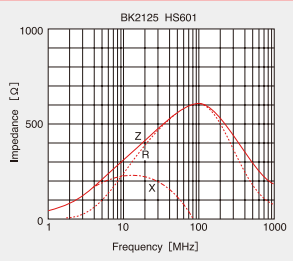

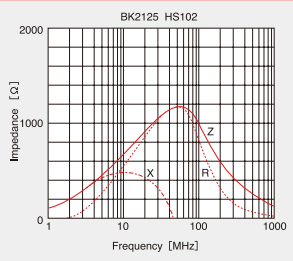

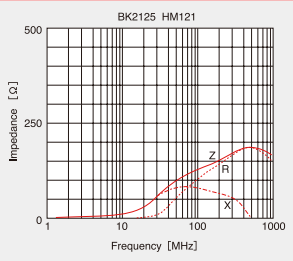

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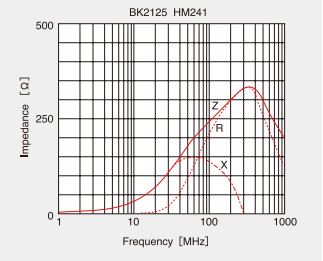
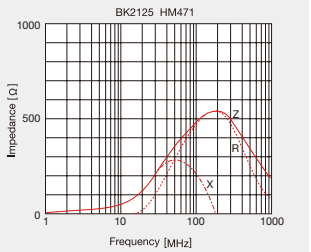
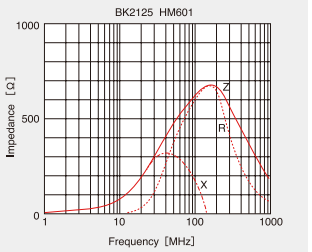
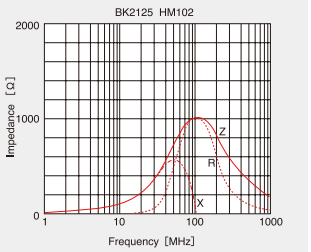
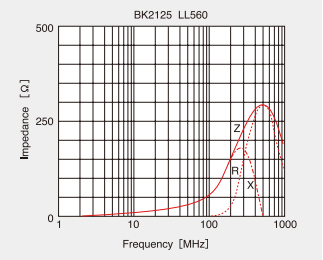
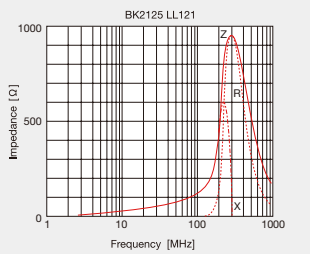


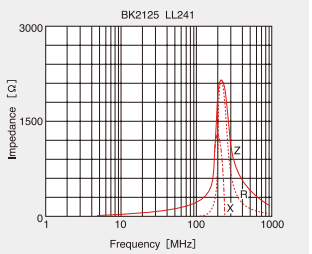


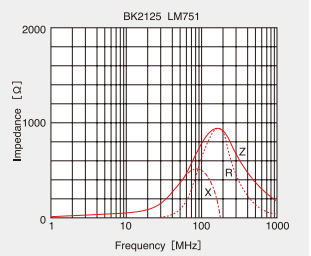


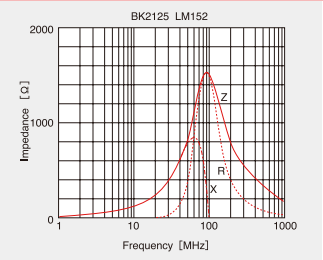


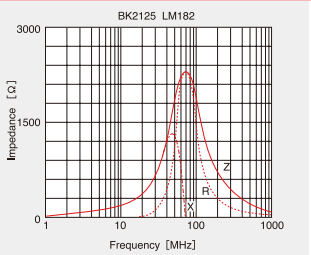


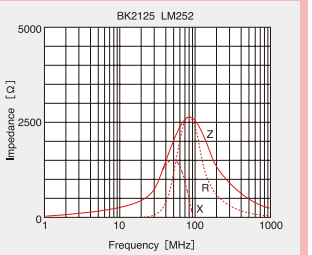












▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

Multilayer chip inductors
Multilayer chip inductors for high frequency, Multilayer chip bead inductors
Multilayer common mode choke coils (MC series F type)
Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■PACKAGING

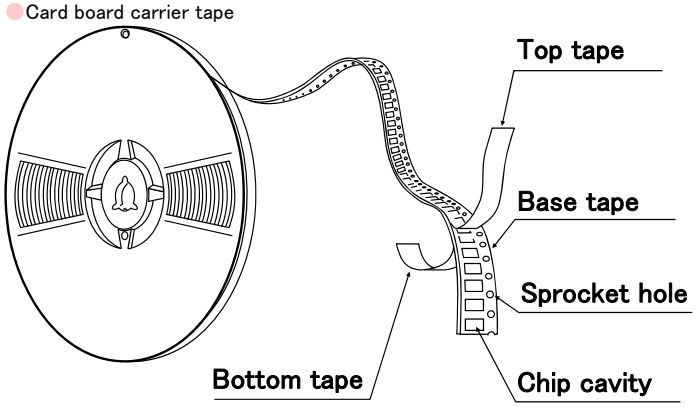
①Minimum Quantity

●Tape & Reel Packaging

Type	Thickness mm (inch)	Standard Quantity [pcs]	
		Paper Tape	Embossed Tape
CK1608 (0603)	0.8 (0.031)	4000	—
CK2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
CKS2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
CKP1608 (0603)	0.8 (0.031)	4000	—
CKP2012 (0805)	0.9 (0.035)	—	3000
CKP2016 (0806)	0.9 (0.035)	—	3000
CKP2520 (1008)	0.7 (0.028)	—	3000
	0.9 (0.035)	—	3000
	1.1 (0.043)	—	2000
NM2012 (0805)	0.9 (0.035)	—	3000
NM2520 (1008)	0.9 (0.035)	—	3000
	1.1 (0.043)	—	2000
LK1005 (0402)	0.5 (0.020)	10000	—
LK1608 (0603)	0.8 (0.031)	4000	—
LK2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
HK0603 (0201)	0.3 (0.012)	15000	—
HK1005 (0402)	0.5 (0.020)	10000	—
HK1608 (0603)	0.8 (0.031)	4000	—
HK2125 (0805)	0.85 (0.033)	—	4000
	1.0 (0.039)	—	3000
HKQ0402 (01005)	0.2 (0.008)	20000	40000
HKQ0603W (0201)	0.3 (0.012)	15000	—
HKQ0603C (0201)	0.3 (0.012)	15000	—
HKQ0603S (0201)	0.3 (0.012)	15000	—
HKQ0603U (0201)	0.3 (0.012)	15000	—
AQ105 (0402)	0.5 (0.020)	10000	—
BK0402 (01005)	0.2 (0.008)	20000	—
BK0603 (0201)	0.3 (0.012)	15000	—
BK1005 (0402)	0.5 (0.020)	10000	—
BKH0603 (0201)	0.3 (0.012)	15000	—
BKH1005 (0402)	0.5 (0.020)	10000	—
BK1608 (0603)	0.8 (0.031)	4000	—
BK2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
BK2010 (0804)	0.45 (0.018)	4000	—
BK3216 (1206)	0.8 (0.031)	—	4000
BKP0402 (01005)	0.2 (0.008)	20000	—
BKP0603 (0201)	0.3 (0.012)	15000	—
BKP1005 (0402)	0.5 (0.020)	10000	—
BKP1608 (0603)	0.8 (0.031)	4000	—
BKP2125 (0805)	0.85 (0.033)	4000	—
MCF0605 (0202)	0.3 (0.012)	15000	—
MCF0806 (0302)	0.4 (0.016)	—	10000
MCF1210 (0504)	0.55 (0.022)	—	5000
MCF2010 (0804)	0.45 (0.018)	—	4000
MCFE1608 (0603)	0.65 (0.026)	4000	-
MCKK2012 (0805)	1.00 (0.039)	-	3000

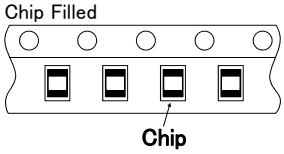
②Taping material

Card board carrier tape

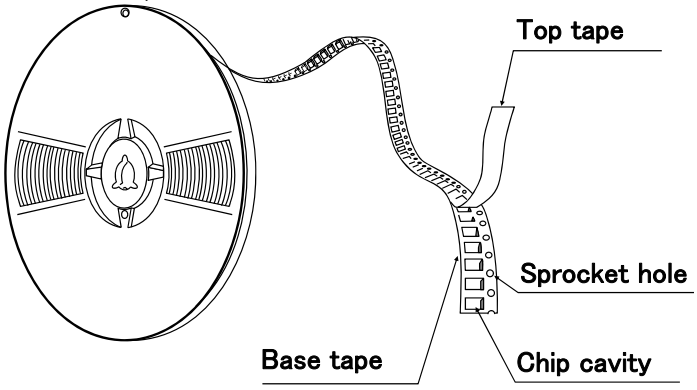


CK	1608
CKP	1608
CK	2125
CKS	2125
LK	1005
LK	1608
LK	2125
HK	0603
HK	1005
HK	1608
HKQ	0402
HKQ	0603
AQ	105

BK	0402
BK	0603
BK	1005
BK	1608
BK	2125
BK	2010
BKP	0402
BKP	0603
BKP	1005
BKP	1608
BKP	2125
BKH	0603
BKH	1005
MCF	0605
MC	1608

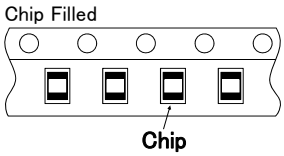


Embossed Tape



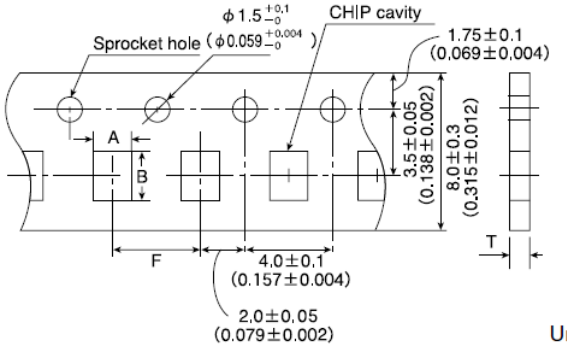
CK	2125
CKS	2125
CKP	2012
CKP	2016
CKP	2520
NM	2012
NM	2520
LK	2125
HKQ	0402
HK	2125

BK	2125
BK	3216
MCF	0806
MCF	1210
MCF	2010
MC	2012



③Taping Dimensions

Paper tape (8mm wide)

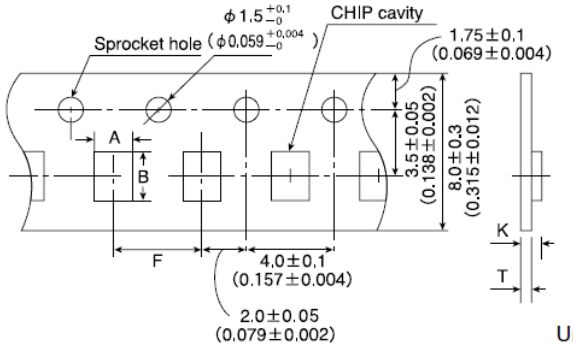


Unit : mm (inch)

Type	Thickness mm(inch)	Chip cavity		Insertion Pitch	Tape Thickness
		A	B	F	T
CK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
CK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
CKS2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
CKP1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
LK1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
LK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
LK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
HK0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HK1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
HK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
HKQ0402(01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
HKQ0603W(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HKQ0603C(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HKQ0603S(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HKQ0603U(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
AQ105(0402)	0.5 (0.020)	0.75±0.1 (0.030±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
BK0402(01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
BK0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
BK1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
BK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BK2010(0804)	0.45(0.018)	1.2±0.1 (0.047±0.004)	2.17±0.1 (0.085±0.004)	4.0±0.1 (0.157±0.004)	0.8max (0.031max)
BKP0402(01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
BKP0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
BKP1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
BKP1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BKP2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BKH0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
BKH1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
MCF0605(0202)	0.3 (0.012)	0.62±0.03 (0.024±0.001)	0.77±0.03 (0.030±0.001)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
MCFE1608(0603)	0.65(0.026)	1.1±0.05 (0.043±0.002)	1.9±0.05 (0.075±0.002)	4.0±0.1 (0.157±0.004)	0.72max (0.028max)

Unit : mm(inch)

● Embossed Tape (8mm wide)

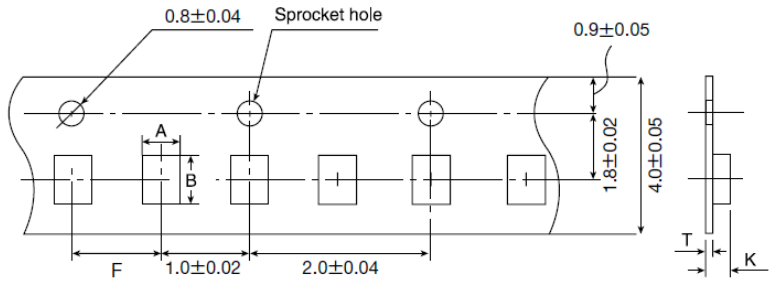


Unit : mm (inch)

Type	Thickness mm(inch)	Chip cavity		Insertion Pitch	Tape Thickness	
		A	B	F	K	T
CK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKS2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKP2012(0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
CKP2016(0806)	0.9 (0.035)	1.8±0.1 (0.071±0.004)	2.2±0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.01)
CKP2520(1008)	0.7 (0.028)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	0.9 (0.035)				1.4 (0.055)	
	1.1 (0.043)				1.7 (0.067)	
NM2012(0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
NM2520(1008)	0.9 (0.035)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	1.1 (0.043)				1.7 (0.067)	
LK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
HK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.5 (0.059)	0.3 (0.012)
	1.0 (0.039)				2.0 (0.079)	
BK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
BK3216(1206)	0.8(0.031)	1.9±0.1 (0.075±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
MCF0806(0302)	0.4 (0.016)	0.75±0.05 (0.030±0.002)	0.95±0.05 (0.037±0.002)	2.0±0.05 (0.079±0.002)	0.55 (0.022)	0.3 (0.012)
MCF1210(0504)	0.55(0.022)	1.15±0.05 (0.045±0.002)	1.40±0.05 (0.055±0.002)	4.0±0.1 (0.157±0.004)	0.65 (0.026)	0.3 (0.012)
MCF2010(0804)	0.45(0.018)	1.1±0.1 (0.043±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	0.85 (0.033)	0.3 (0.012)
MCKK2012(0805)	1.0 (0.039)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.010)

Unit : mm(inch)

Embossed Tape (4mm wide)

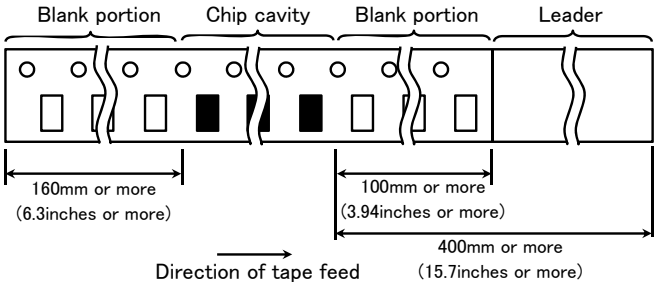


Unit : mm

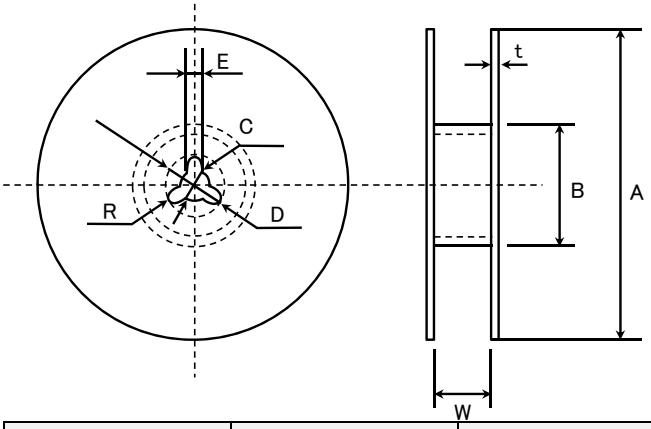
Type	Thickness mm(inch)	Chip cavity		Insertion Pitch	Tape Thickness	
		A	B	F	K	T
HKQ0402(01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.

Unit : mm

④LEADER AND BLANK PORTION



⑤Reel Size



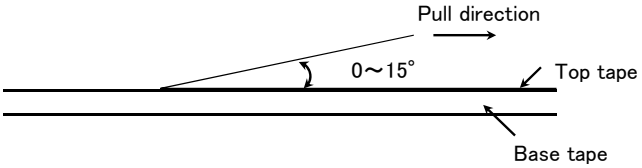
A	B	C	D	E	R
ϕ178±2.0	ϕ50 or more	ϕ13.0±0.2	ϕ21.0±0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

(Unit : mm)

⑥Top tape strength

The top tape requires a peel-off force of 0.1～0.7N in the direction of the arrow as illustrated below.



■RELIABILITY DATA

1. Operating Temperature Range			
Specified Value	BK0402		−55～＋125℃
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		−55～＋85℃
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		−40～＋85℃
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		−40～＋85℃
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		−55～＋125℃
	HK0603		
	HK1005		
	HK1608		−40～＋85℃
	HK2125		
	HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U/		−55～＋125℃
	AQ105		
	MCFE1608		−40～＋125℃(Including self-generated heat)
	MCKK2012		

2. Storage Temperature Range			
Specified Value	BK0402		−55～＋125℃
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		−55～＋85℃
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		−40～＋85℃
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		−40～＋85℃
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		−55～＋125℃
	HK0603		
	HK1005		
	HK1608		−40～＋85℃
	HK2125		
	HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U/		−55～＋125℃
	AQ105		
	MCFE1608		−40～＋85℃
	MCKK2012		

3. Rated Current			
Specified Value	BK0402		150～750mA DC
	BK0603		100～500mA DC
	BK1005		120～1000mA DC
	BKH0603		115～450mA DC
	BKH1005		200～300mA DC
	BK1608		150～1500mA DC
	BK2125		200～1200mA DC
	ARRAY	BK2010	100mA DC
		BK3216	100～200mA DC
	BKP0402		0.55～1.1A DC
	BKP0603		0.8～1.8A DC
	BKP1005		0.8～2.4A DC
	BKP1608		1.0～3.0A DC
	BKP2125		1.5～4.0A DC
	MCF 0605		0.05A DC
	MCF 0806		0.1～0.13A DC
	MCF 1210		0.1～0.15A DC
	MCF 2010		0.1A DC
	CK1608		50～60mA DC
	CK2125		60～500mA DC
	CKS2125		110～280mA DC
	CKP1608		0.35～0.9A DC
	CKP2012		0.7～1.7A DC
	CKP2016		0.9～1.6A DC
	CKP2520		1.1～1.8A DC
	NM2012		1.0～1.2A DC
	NM2520		0.9～1.2A DC
	LK1005		20～25mA DC
	LK1608		1～150mA DC
	LK2125		5～300mA DC
	HK0603		60～470mA DC
	HK1005		110～300mA DC (−55～+125℃) 200～900mA DC (−55～+85℃)
	HK1608		150～300mA DC
	HK2125		300mA DC
	HKQ0402		100～500mA DC
	HKQ0603W		100～850mA DC
	HKQ0603C		160～850mA DC
	HKQ0603S		130～600mA DC
	HKQ0603U		190～900mA DC
	AQ105		280～710mA DC
	MCFE1608		Idc1 :1400～2600mA DC, Idc2 :800～1500mA DC
	MCKK2012		Idc1 :2000mA DC, Idc2 :1400mA DC

Definition of rated current:

・In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20℃.

・In the BK Series P type, CK Series P type, NM Series, the rated current is the value of current at which the temperature of the element is increased within 40℃.

・In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20℃.

・In the HKQ0402(～9N1), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20℃.

・In the HKQ0402(10N～), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25℃.

・In the MC Series, Idc1 is the DC value at which the initial L value is decreased within 30% and Idc2 is the DC value at which the temperature of element is increased within 40℃ by the application of DC bias. (at 20℃)

4. Impedance			
Specified Value	BK0402		10～330Ω ±5Ω(10Ω), ±25%(Other)
	BK0603		10～1200Ω ±25%
	BK1005		10～1800Ω ±25%
	BKH0603		25～1500Ω ±25%
	BKH1005		600～1800Ω ±25%
	BK1608		22～2500Ω ±25%
	BK2125		15～2500Ω ±25%
	ARRAY	BK2010	5～1000Ω ±25%
		BK3216	60～1000Ω ±25%
	BKP0402		10～33Ω ±5Ω(10Ω)、±25%(Other)
	BKP0603		10～120Ω ±5Ω(10Ω), ±25%(Other)
	BKP1005		10～330Ω ±5Ω(EM100), ±25%(Other)
	BKP1608		33～470Ω ±25%
	BKP2125		33～330Ω ±25%
	MCF 0605		12～90Ω ±5Ω(12Ω), ±20%(35Ω), ±25%(Other)
	MCF 0806		12～90Ω ±5Ω(12Ω), ±20%(Other)
	MCF 1210		40～90Ω ±20%(2H900),±25%(Other)
	MCF 2010		90Ω ±25%
	CK1608		–
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		

Test Methods and Remarks

BK0402Series, BKP0402Series
- Measuring frequency : 100±1MHz
- Measuring equipment : E4991A(or its equivalent)
- Measuring jig : 16197A(or its equivalent)

BK0603Series, BKP0603Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent)
- Measuring jig : 16193A(or its equivalent)

BK1005Series, BKP1005Series ,BKH1005Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent)
- Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)

BK1608・2125Series, BKP1608・2125Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)
- Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW

BK2010・3216Series, MCF Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)
- Measuring jig : 16192A(or its equivalent)

5. Inductance

Specified Value	BK0402		—
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		4.7～10.0 μH: ±20%
	CK2125		0.1～10.0 μH: ±20%
	CKS2125		1.0～10.0 μH: ±20%
	CKP1608		0.33～2.2 μH: ±20%
	CKP2012		0.47～4.7 μH: ±20%
	CKP2016		0.47～4.7 μH: ±20%
	CKP2520		0.47～4.7 μH: ±20%
	NM2012		0.82～1.0 μH: ±20%
	NM2520		1.0～2.2 μH: ±20%
	LK1005		0.12～2.2 μH: ±10 or 20%
	LK1608		0.047～33.0 μH: ±20%　0.10～12.0 μH: ±10%
	LK2125		0.047～33.0 μH: ±20%　0.10～12.0 μH: ±10%
	HK0603		1.0～6.2nH: ±0.3nH　6.8～100nH: ±5%
	HK1005		1.0～6.2nH: ±0.3nH　6.8～270nH: ±5%
	HK1608		1.0～5.6nH: ±0.3nH　6.8～470nH: ±5%
	HK2125		1.5～5.6nH: ±0.3nH　6.8～470nH: ±5%
	HKQ0402		0.5～3.9nH: ±0.1 or 0.2 or 0.3nH　4.3～5.6nH: ±0.3nH or 3% or 5% 6.2～47nH: ±3 or 5%
	HKQ0603W		0.6～3.9nH: ±0.1 or 0.2 or 0.3nH　4.3～6.2nH: ±0.2 or 0.3nH or 3 or 5% 6.8～27nH: ±3 or 5%　33～100nH: ±5%
	HKQ0603C		0.6～3.9nH: ±0.1 or 0.2 or 0.3nH　4.3～6.2nH: ±0.2 or 0.3nH　6.8～22nH: ±3 or 5%
	HKQ0603S		0.6～6.2nH: ±0.2 or 0.3nH　6.8～22nH: ±3 or 5%
	HKQ0603U		0.6～4.2nH: ±0.1 or 0.2 or 0.3nH　4.3～6.5nH: ±0.2 or 0.3nH　6.8～22nH: ±3 or 5%
	AQ105		1.0～6.2nH: ±0.3nH　6.8～15nH: ±5%
	MCFE1608		0.24～1.0 μH: ±20%
	MCKK2012		1.0　μH: ±20%

Test Methods and Remarks

CK、LK、CKP、NM、MC Series

- Measuring frequency : 2～4MHz(CK1608)
- Measuring frequency : 2～25MHz(CK2125)
- Measuring frequency : 2～10MHz(CKS2125)
- Measuring frequency : 10～25MHz(LK1005)
- Measuring frequency : 1～50MHz(LK1608)
- Measuring frequency : 0.4～50MHz(LK2125)
- Measuring frequency : 1MHz(CKP1608・CKP2012・CKP2016・CKP2520・NM2012・NM2520・MCFE1608・MCKK2012)
- Measuring equipment /jig :・4194A＋16085B＋16092A(or its equivalent)　・4195A＋41951＋16092A(or its equivalent)
  ・4294A＋16192A(or its equivalent)　・4291A＋16193A(or its equivalent)/LK1005
  ・4285A＋42841A＋42842C＋42851－61100(or its equivalent)/CKP1608・CKP2012・CKP2016・CKP2520・NM2012・NM2520・MCFE1608・MCKK2012
- Measuring current :・1mA rms(0.047～4.7 μH)
  ・0.1mA rms(5.6～33 μH)

HK、HKQ、AQ Series

- Measuring frequency : 100MHz(HK0603・HK1005・AQ105)
- Measuring frequency : 50/100MHz(HK1608・HK2125)
- Measuring frequency : 500MHz(HKQ0603C・HKQ0603S・HKQ0603U)
- Measuring frequency : 300/500MHz(HKQ0603W)
- Measuring frequency : 100/500MHz(HKQ0402)
- Measuring equipment /jig :・4291A＋16197A(or its equivalent)/HK0603・AQ105
  ・4291A＋16193A(or its equivalent)/HK1005
  ・E4991A＋16197A(or its equivalent)/HKQ0603S・HKQ0603U・HKQ0603W・HKQ0603C
  ・4291A＋16092A ＋ in-house made jig(or its equivalent)/HK1608・HK2125
  ・E4991A＋16196D(or its equivalent)/HKQ0402

6. Q			
Specified Value	BK0402		—
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		—
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		10～20 min.
	LK1608		10～35 min.
	LK2125		15～50 min.
	HK0603		4～5 min.
	HK1005		8 min.
	HK1608		8～12 min.
	HK2125		10～18 min.
	HKQ0402		3～8 min.
	HKQ0603W		6～15 min.
	HKQ0603C		14～15 min.
	HKQ0603S		10～13 min.
	HKQ0603U		14 min.
	AQ105		8 min.
	MCFE1608		—
	MCKK2012		

Test Methods and Remarks

LK Series

Measuring frequency	: 10～25MHz(LK1005)
Measuring frequency	: 1～50MHz(LK1608)
Measuring frequency	: 0.4～50MHz(LK2125)
Measuring equipment /jig	:・4194A＋16085B＋16092A(or its equivalent)
	・4195A＋41951＋16092A(or its equivalent)
	・4294A＋16192A(or its equivalent)
	・4291A＋16193A(or its equivalent)/LK1005
Measuring current	・1mA rms(0.047～4.7 μH)
	・0.1mA rms(5.6～33 μH)

HK、HKQ、AQ Series

Measuring frequency	: 100MHz(HK0603・HK1005・AQ105)
Measuring frequency	: 50/100MHz(HK1608・HK2125)
Measuring frequency	: 500MHz(HKQ0603C・HKQ0603S・HKQ0603U)
Measuring frequency	: 300/500MHz(HKQ0603W)
Measuring frequency	: 100/500MHz(HKQ0402)
Measuring equipment /jig	:・4291A＋16197A(or its equivalent)/HK0603・AQ105
	・4291A＋16193A(or its equivalent)/HK1005
	・E4991A＋16197A(or its equivalent)/HKQ0603S・HKQ0603U・HKQ0603W・HKQ0603C
	・4291A＋16092A ＋ in-house made jig(or its equivalent)/HK1608, HK2125
	・E4991A＋16196D(or its equivalent)HKQ0402

7. DC Resistance			
Specified Value	BK0402		0.07～1.2Ω max.
	BK0603		0.065～1.50Ω max.
	BK1005		0.03～0.90Ω max.
	BKH0603		0.26～3.20Ω max.
	BKH1005		0.85～2.00Ω max.
	BK1608		0.05～1.10Ω max.
	BK2125		0.05～0.75Ω max.
	ARRAY	BK2010	0.10～0.90Ω max.
		BK3216	0.15～0.80Ω max.
	BKP0402		0.05～0.15Ω max.
	BKP0603		0.030～0.180Ω max.
	BKP1005		0.0273～0.220Ω max.
	BKP1608		0.025～0.18Ω max.
	BKP2125		0.020～0.075Ω max.
	MCF 0605		2.5～6.5Ω max
	MCF 0806		2.5～5.0Ω max.
	MCF 1210		2.5～4.5Ω max.
	MCF 2010		4.5Ω max.
	CK1608		0.45～0.85Ω(±30%)
	CK2125		0.16～0.65Ω max.
	CKS2125		0.12～0.52Ω max.
	CKP1608		0.15～0.35Ω max.
	CKP2012		0.08～0.28Ω max.
	CKP2016		0.075～0.20Ω max
	CKP2520		0.05～0.16Ω max.
	NM2012		0.10～0.15Ω max.
	NM2520		0.11～0.22Ω max.
	LK1005		0.41～1.16Ω max.
	LK1608		0.2～2.2Ω max.
	LK2125		0.1～1.1Ω max.
	HK0603		0.11～3.74Ω max.
	HK1005		0.08～4.8Ω max.
	HK1608		0.05～2.6Ω max.
	HK2125		0.10～1.5Ω max.
	HKQ0402		0.08～5.0Ω max.
	HKQ0603W		0.07～4.1Ω max.
	HKQ0603C		0.07～1.6Ω max.
	HKQ0603S		0.06～1.29Ω max.
	HKQ0603U		0.06～1.29Ω max.
	AQ105		0.07～0.45Ω max.
	MCFE1608		0.100～0.340Ω max.
	MCKK2012		0.123Ω max.
Test Methods and Remarks	Measuring equipment：VOAC-7412, VOAC-7512, VOAC-7521（made by Iwasaki Tsushinki）, HIOKI3227 (or its equivalent)		

8. Self Resonance Frequency (SRF)			
Specified Value	BK0402		—
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		17～25MHz min.
	CK2125		24～235MHz min.
	CKS2125		24～75MHz min.
	CKP1608		—
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		40～180MHz min.
	LK1608		9～260MHz min.
	LK2125		13～320MHz min.
	HK0603		900～10000MHz min.
	HK1005		400～10000MHz min.
	HK1608		300～10000MHz min.
	HK2125		200～4000MHz min.
	HKQ0402		1200～10000MHz min.
	HKQ0603W		800～10000MHz min.
	HKQ0603C		2500～10000MHz min.
	HKQ0603S		1900～10000MHz min.
	HKQ0603U		1900～10000MHz min.
	AQ105		2300～10000MHz min.
	MCFE1608		—
	MCKK2012		
Test Methods and Remarks	LK、CK Series : Measuring equipment : 4195A (or its equivalent) Measuring jig : 41951＋16092A (or its equivalent) HK、HKQ、AQ Series : Measuring equipment : 8719C (or its equivalent)・8753D (or its equivalent)/HK2125		

9. Temperature Characteristic

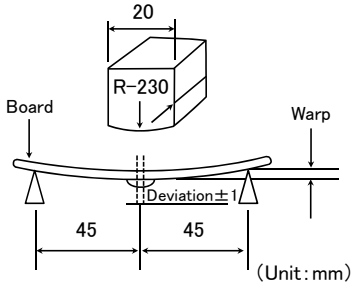
Specified Value	BK0402		−
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		Inductance change : Within ±10%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
Test Methods and Remarks	HK、HKQ、AQ Series: Temperature range : −30～+85℃ Reference temperature : +20℃		
	MC Series: Temperature range : −40～+85℃ Reference temperature : +20℃		

10. Resistance to Flexure of Substrate

Specified Value	BK0402		No mechanical damage.
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		

Test Methods and Remarks

Warp : 2mm(BK Series without 0402size、BKP、BKH1005、CK、CKS、CKP、NM、LK、HK、HKQ0603S、HKQ0603U、AQ Series、MCF1210、MC Series)
: 1mm(BK0402、BKP0402、BKH0603、HKQ0402、HKQ0603W、HKQ0603C Series、MCF Series without 1210 size,)
Testing board : glass epoxy-resin substrate
Thickness : 0.8mm



11. Solderability			
Specified Value	BK0402		At least 75% of terminal electrode is covered by new solder.
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		At least 75% of terminal electrode is covered by new solder.
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
Test Methods and Remarks	Solder temperature	:230±5℃ (JIS Z 3282 H60A or H63A)	
	Solder temperature	:245±3℃ (Sn/3.0Ag/0.5Cu)	
	Duration	:4±1 sec.	

12. Resistance to Soldering			
Specified Value	BK0402		Appearance : No significant abnormality Impedance change : Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance : No significant abnormality Impedance change : Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Remaining terminal electrode : 70% min Inductance change R10～4R7 : Within ±10% 6R8～100 : Within ±15% CKS2125 : Within ±20% CKP1608、CKP2012、CKP2016、CKP2520、NM2012、NM2520 : Within ±30%
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change : Within ±15%
	LK1608		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change 47N～4R7 : Within ±10% 5R6～330 : Within ±15%
	LK2125		
	HK0603		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change : Within ±5%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change : Within ±10%
	MCKK2012		
Test Methods and Remarks	Solder temperature	: 260±5℃	
	Duration	: 10±0.5 sec.	
	Preheating temperature	: 150 to 180℃	
	Preheating time	: 3 min.	
	Flux	: Immersion into methanol solution with colophony for 3 to 5 sec.	
	Recovery	: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1)	

(Note 1) When there are questions concerning measurement result ; measurement shall be made after 48±2 hrs of recovery under the standard condition.

13. Thermal Shock

Specified Value	BK0402		Appearance：No significant abnormality Impedance change： Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance：No significant abnormality Impedance change： Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Inductance change：Within ±20% Q change：Within ±30%
	CK2125		
	CKS2125		Inductance change：Within ±20% (CKS2125)
	CKP1608		No mechanical damage. Inductance change： Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change： Within ±10% Q change： Within ±30%
	LK1608		
	LK2125		
	HK0603		No mechanical damage. Inductance change： Within ±10% Q change： Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		Appearance：No significant abnormality Inductance change： Within ±10%
	MCKK2012		

Test Methods and Remarks

Conditions for 1 cycle

Step	temperature(℃)	time(min.)
1	Minimum operating temperature +0/−3	30±3
2	Room temperature	2～3
3	Maximum operating temperature +3/−0	30±3
4	Room temperature	2～3

Number of cycles：5

Recovery：2 to 3 hrs of recovery under the standard condition after the test.(See Note 1)

(Note 1) When there are questions concerning measurement result；measurement shall be made after 48±2 hrs of recovery under the standard condition.

14. Damp Heat(Steady state)			
Specified Value	BK0402		Appearance:No significant abnormality Impedance change: Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance:No significant abnormality Impedance change: Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%
	CK2125		
	CKS2125		Inductance change: Within ±20%
	CKP1608		No mechanical damage. Inductance change: Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change: Within ±10% Q change: Within ±30%
	LK1608		
	LK2125		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%
	HK0603		No mechanical damage. Inductance change: Within ±10% Q change: Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MC1608		Appearance:No significant abnormality Inductance change: Within ±10%
	MC2012		
Test Methods and Remarks	BK、BKP、BKH Series、MCF Series: Temperature :40±2℃ Humidity :90 to 95%RH Duration :500+24/−0 hrs Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1) LK、CK、CKS、CKP、NM、HK、HKQ、AQ、MC Series: Temperature :40±2℃(LK、CK、CKS、CKP、NM Series) :60±2℃(HK、HKQ、AQ、MC Series) Humidity :90 to 95%RH Duration :500±12 hrs Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1)		

(Note 1) When there are questions concerning measurement result;measurement shall be made after 48±2 hrs of recovery under the standard condition.

15. Loading under Damp Heat			
Specified Value	BK0402		Appearance：No significant abnormality Impedance change： Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	CK1608		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	CK2125		
	CKS2125		No mechanical damage. Inductance change： Within ±20%
	CKP1608		No mechanical damage. Inductance change： Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change： Within ±10% Q change： Within ±30%
	LK1608		No mechanical damage. Inductance change： 0.047～12.0 μH： Within ±10% 15.0～33.0 μH： Within ±15% Q change： Within ±30%
	LK2125		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	HK0603		No mechanical damage. Inductance change： Within ±10% Q change： Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		Appearance：No significant abnormality Inductance change： Within ±10%
	MCKK2012		
Test Methods and Remarks	BK、BKP、BKH Series： Temperature ：40±2℃ Humidity ：90 to 95%RH Applied current ：Rated current Duration ：500＋24／－0 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1) LK、CK、CKS、CKP、NK、HK、HKQ、AQ、MC Series： Temperature ：40±2℃(LK、CK、CKS、CKP、NM Series) ：60±2℃(HK、HKQ、AQ、MC Series) Humidity ：90 to 95%RH Applied current ：Rated current Duration ：500±12 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1)		

Note on standard condition: "standard condition" referred to herein is defined as follows:
5 to 35℃ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.
When there are questions concerning measurement results:
In order to provide correlation data, the test shall be conducted under condition of 20±2℃ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.
Unless otherwise specified, all the tests are conducted under the "standard condition."
(Note 1) Measurement shall be made after 48±2 hrs of recovery under the standard condition.

16. Loading at High Temperature			
Specified Value	BK0402		Appearance：No significant abnormality Impedance change： Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance：No significant abnormality Impedance change： Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	CK2125		
	CKS2125		No mechanical damage. Inductance change： Within ±20%
	CKP1608		No mechanical damage. Inductance change： Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change： Within ±10% Q change： Within ±30%
	LK1608		No mechanical damage. Inductance change： 0.047～12.0 μH： Within ±10% 15.0～33.0 μH： Within ±15% Q change： Within ±30%
	LK2125		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	HK0603		No mechanical damage. Inductance change： Within ±10% Q change： Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		Appearance：No significant abnormality Inductance change： Within ±10%
	MCKK2012		
Test Methods and Remarks	BK、BKH、BKP Series、MCF Series： Temperature ：125±3℃(BK、BKH Series) ：85±3℃(BKP、MCF Series) Applied current ：Rated current Duration ：500+24/−0 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) LK、CK、CKS、CKP、NM、HK、HKQ、AQ、MC Series： Temperature ：85±2℃(LK、CK、CKS、CKP、NM、MC Series) ：85±2℃(HK1608, 2125) ：85±2℃(HK1005, AQ105 operating temperature range−55～+85℃) ：125±2℃(HKQ0402, HK0603, HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105 operating temperature range−55～+125℃) Applied current ：Rated current Duration ：500±12 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the test.(See Note 1)		

Note on standard condition: "standard condition" referred to herein is defined as follows:
5 to 35℃ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.
When there are questions concerning measurement results:
In order to provide correlation data, the test shall be conducted under condition of 20±2℃ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."
(Note 1) Measurement shall be made after 48±2 hrs of recovery under the standard condition.

Precautions on the use of Multilayer chip inductors
Multilayer chip inductors for high frequency, Multilayer chip bead inductors
Multilayer common mode choke coils (MC series F type)
Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■PRECAUTIONS

1. Circuit Design

Precautions

◆Verification of operating environment, electrical rating and performance

1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications.
   As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

◆Operating Current (Verification of Rated current)

1. The operating current for inductors must always be lower than their rated values.
2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

2. PCB Design

Precautions

◆Pattern configurations (Design of Land-patterns)

1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.
   Therefore, the following items must be carefully considered in the design of solder land patterns:
   (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
   (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
   (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.

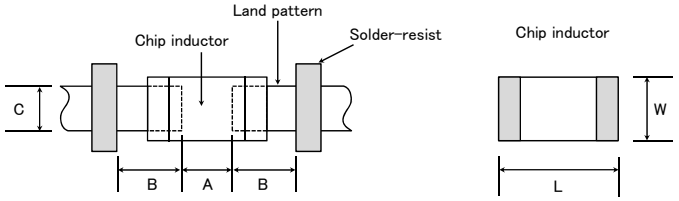
◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)

1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.

Technical considerations

◆Pattern configurations (Design of Land-patterns)

1. The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
   (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



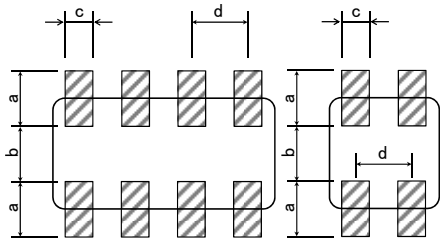
Recommended land dimensions for wave-soldering (Unit: mm)

Type		1608	2012	2125	2016	2520	3216
Size	L	1.6	2.0	2.0	2.0	2.5	3.2
	W	0.8	1.25	1.25	1.6	2.0	1.6
A		0.8～1.0	1.0～1.4	1.0～1.4	1.0～1.4	1.0～1.4	1.8～2.5
B		0.5～0.8	0.8～1.5	0.8～1.5	0.8～1.5	0.6～1.0	0.8～1.7
C		0.6～0.8	0.9～1.2	0.9～1.2	1.3～1.6	1.6～2.0	1.2～1.6

Recommended land dimensions for reflow-soldering (Unit: mm)

Type		0402	0603	1005	105	1608	2012	2125	2016	2520	3216
Size	L	0.4	0.6	1.0	1.0	1.6	2.0	2.0	2.0	2.5	3.2
	W	0.2	0.3	0.5	0.6	0.8	1.25	1.25	1.6	2.0	1.6
A		0.15～0.25	0.20～0.30	0.45～0.55	0.50～0.55	0.8～1.0	0.8～1.2	0.8～1.2	0.8～1.2	1.0～1.4	1.8～2.5
B		0.10～0.20	0.20～0.30	0.40～0.50	0.30～0.40	0.6～0.8	0.8～1.2	0.8～1.2	0.8～1.2	0.6～1.0	0.6～1.5
C		0.15～0.30	0.25～0.40	0.45～0.55	0.60～0.70	0.6～0.8	0.9～1.6	0.9～1.6	1.2～2.0	1.8～2.2	1.2～2.0

Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.

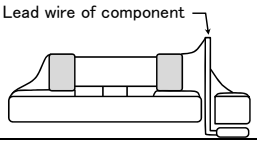
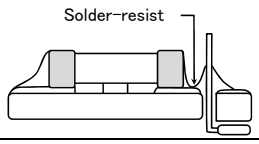
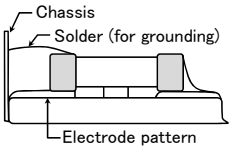
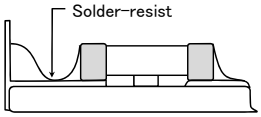
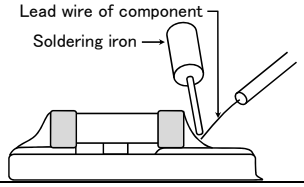
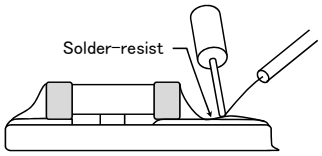
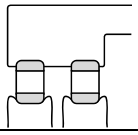
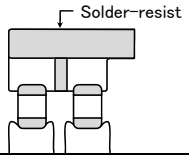


Recommended land dimension for Reflow-soldering

Type		3216	2010	1210	0806	0605
Size	L	3.2	2.0	1.25	0.85	0.65
	W	1.6	1.0	1.0	0.65	0.50
a		0.7～0.9	0.5～0.6	0.45～0.55	0.25～0.35	0.27～0.33
b		0.8～1.0	0.5～0.6	0.7～0.8	0.25～0.35	0.17～0.23
c		0.4～0.5	0.2～0.3	0.25～0.35	0.25～0.35	0.20～0.26
d		0.8	0.5	0.55	0.5	0.4

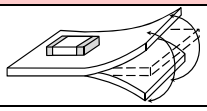
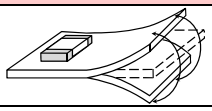
(Unit : mm)

((2) Examples of good and bad solder application

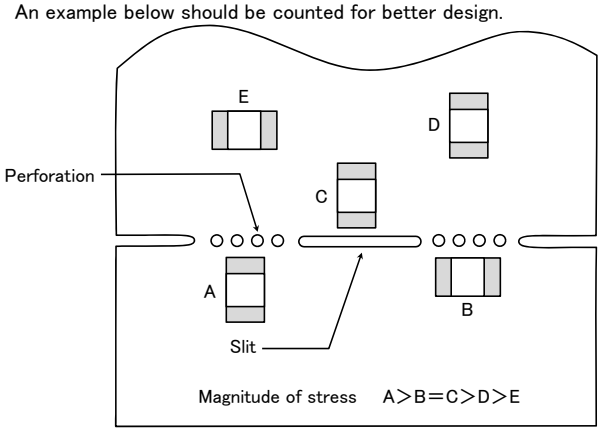
Item	Not recommended	Recommended
Mixed mounting of SMD and leaded components		
Component placement close to the chassis		
Hand-soldering of leaded components near mounted components		
Horizontal component placement		

◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)

1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended
Deflection of the board		 Position the component at a right angle to the direction of the mechanical stresses that are anticipated.

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.
An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

3. Considerations for automatic placement

Precautions

◆Adjustment of mounting machine

1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
2. The maintenance and inspection of the mounter should be conducted periodically.

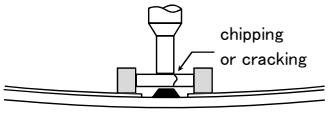
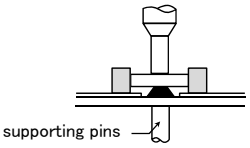
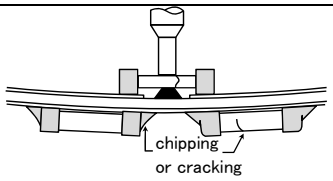
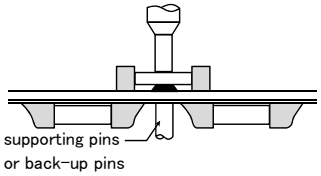
◆Selection of Adhesives

1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.

Technical considerations

◆Adjustment of mounting machine

1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
   (1) The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
   (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
   (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

Item	Improper method	Proper method
Single-sided mounting		
Double-sided mounting		

2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.

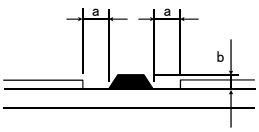
◆Selection of Adhesives

1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
   (1) Required adhesive characteristics
      a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
      b. The adhesive should have sufficient strength at high temperatures.
      c. The adhesive should have good coating and thickness consistency.
      d. The adhesive should be used during its prescribed shelf life.
      e. The adhesive should harden rapidly.
      f. The adhesive must not be contaminated.
      g. The adhesive should have excellent insulation characteristics.
      h. The adhesive should not be toxic and have no emission of toxic gasses.
   (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

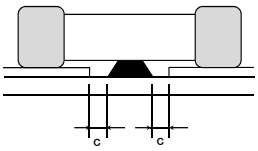
[Recommended conditions]

Figure	0805 case sizes as examples
a	0.3mm min
b	100～120 μm
c	Area with no adhesive

Amount of adhesives



After inductors are bonded



4. Soldering

Precautions

◆Selection of Flux

1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
   (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
   (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
   (3) When using water-soluble flux, special care should be taken to properly clean the boards.

◆Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

Technical considerations

◆Selection of Flux

1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.

1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.

1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

◆Soldering

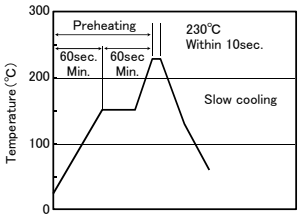
1-1. Preheating when soldering

Heating: Chip inductor components should be preheated to within 100 to 130℃ of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100℃.

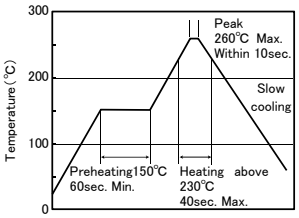
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock.

[Reflow soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】

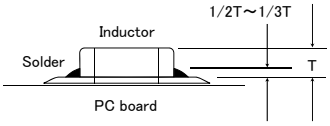


※Ceramic chip components should be preheated to within 100 to 130℃ of the soldering.

※Assured to be reflow soldering for 2 times.

Caution

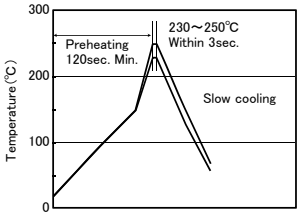
1. The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:



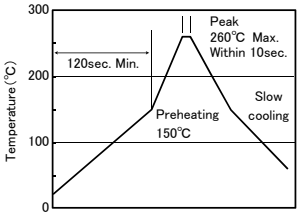
2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】



※Ceramic chip components should be preheated to within 100 to 130℃ of the soldering.

※Assured to be wave soldering for 1 time.

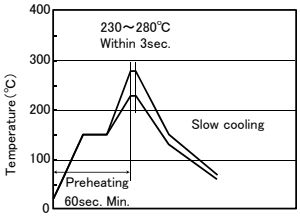
※Except for reflow soldering type.

Caution

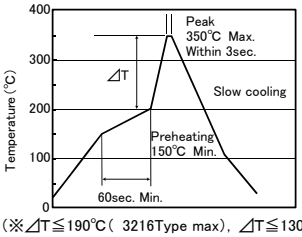
1. Make sure the inductors are preheated sufficiently.
2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130℃.
3. Cooling after soldering should be as gradual as possible.
4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

【Recommended conditions for eutectic soldering



【Recommended condition for Pb-free soldering】



(※⊿T≦190℃(3216Type max), ⊿T≦130℃(3225 Type min)

※It is recommended to use 20W soldering iron and the tip is 1φ or less.

※The soldering iron should not directly touch the components.

※Assured to be soldering iron for 1 time.

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

	Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

5. Cleaning	
Precautions	◆Cleaning conditions 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux used and purpose of the cleaning(e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics.
Technical considerations	◆Cleaning conditions 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties(especially insulation resistance). 2. Inappropriate cleaning conditions(insufficient or excessive cleaning)may detrimentally affect the performance of the inductors. (1) Excessive cleaning a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked; Ultrasonic output Below 20W/ℓ Ultrasonic frequency Below 40kHz Ultrasonic washing period 5 min. or less

6. Post cleaning processes	
Precautions	◆Application of resin coatings, moldings, etc. to the PCB and components. 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance. 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction. 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors. The use of such resins, molding materials etc. is not recommended.

7. Handling	
Precautions	◆Breakaway PC boards(splitting along perforations) 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆General handling precautions 1. Always wear static control bands to protect against ESD. 2. Keep the inductors away from all magnets and magnetic objects. 3. Use non-magnetic tweezers when handling inductors. 4. Any devices used with the inductors(soldering irons, measuring instruments) should be properly grounded. 5. Keep bare hands and metal products(i.e., metal desk)away from chip electrodes or conductive areas that lead to chip electrodes. 6. Keep inductors away from items that generate magnetic fields such as speakers or coils. ◆Mechanical considerations 1. Be careful not to subject the inductors to excessive mechanical shocks. (1) If inductors are dropped on the floor or a hard surface they should not be used. (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible. Recommended conditions Ambient temperature Below 30℃ Humidity Below 70% RH The ambient temperature must be kept below 40℃. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery. *The packaging material should be kept where no chlorine or sulfur exists in the air.
Technical considerations	◆Storage 1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.